## Surface Mount Trench MOS Barrier Schottky Rectifier

## FEATURES

- Very low profile - typical height of 0.95 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low power losses, high efficiency

- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of $260^{\circ} \mathrm{C}$
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


## TYPICAL APPLICATIONS

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

## MECHANICAL DATA

Case: DO-221BC (SMPA)
Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade
Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD22-B102
M3 suffix meets JESD 201 class 2 whisker test
Polarity: Color band denotes cathode end

| PRIMARY CHARACTERISTICS |  |
| :---: | :---: |
| $\mathrm{I}_{\mathrm{F}(\mathrm{AV}}$ | 8.0 A |
| $\mathrm{~V}_{\mathrm{RRM}}$ | 50 V |
| $\mathrm{I}_{\mathrm{FSM}}$ | 120 A |
| $\mathrm{~V}_{\mathrm{F}}$ at $\mathrm{I}_{\mathrm{F}}=8.0 \mathrm{~A}\left(\mathrm{~T}_{\mathrm{A}}=125^{\circ} \mathrm{C}\right)$ | 0.40 V |
| $\mathrm{~T}_{\mathrm{J}}$ max. | $150{ }^{\circ} \mathrm{C}$ |
| Package | DO-221BC (SMPA) |
| Diode variation | Single die |


| MAXIMUM RATINGS ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise noted) |  |  |  |
| :---: | :---: | :---: | :---: |
| PARAMETER | SYMBOL | V8PAL50 | UNIT |
| Device marking code |  | 8L5 |  |
| Maximum repetitive peak reverse voltage | $\mathrm{V}_{\text {RRM }}$ | 50 | V |
| Maximum DC forward current | $\mathrm{I}_{\mathrm{F}}{ }^{(1)}$ | 8.0 | A |
|  | $\mathrm{I}_{\mathrm{F}}{ }^{(2)}$ | 4.0 |  |
| Maximum DC reverse voltage | $V_{D C}$ | 35 | V |
| Peak forward surge current 10 ms single half sine-wave superimposed on rated load | $\mathrm{I}_{\text {FSM }}$ | 120 | A |
| Operating junction and storage temperature range | $\mathrm{T}_{\mathrm{J},}, \mathrm{T}_{\text {StG }}$ | -40 to +150 | ${ }^{\circ} \mathrm{C}$ |

## Notes

${ }^{(1)}$ Units mounted on $3 \mathrm{~cm} \times 3 \mathrm{~cm}$ Aluminum, 2 oz. РСВ
${ }^{(2)}$ Free air, mounted on recommended copper pad area

ELECTRICAL CHARACTERISTICS $\left(T_{A}=25^{\circ} \mathrm{C}\right.$ unless otherwise noted)

| PARAMETER | TEST CONDITIONS |  | SYMBOL | TYP. | MAX. | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Instantaneous forward voltage | $\mathrm{I}_{\mathrm{F}}=4.0 \mathrm{~A}$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | $V_{F}{ }^{(1)}$ | 0.43 | - |  |
|  | $\mathrm{I}_{\mathrm{F}}=8.0 \mathrm{~A}$ |  |  | 0.49 | 0.57 |  |
|  | $\mathrm{I}_{\mathrm{F}}=4.0 \mathrm{~A}$ | $\mathrm{T}_{\mathrm{A}}=125^{\circ} \mathrm{C}$ |  | 0.32 | - | V |
|  | $\mathrm{I}_{\mathrm{F}}=8.0 \mathrm{~A}$ |  |  | 0.40 | 0.48 |  |
| Reverse current |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{R}}{ }^{(2)}$ | 10 | - | $\mu \mathrm{A}$ |
|  | $\mathrm{V}_{\mathrm{R}}=35 \mathrm{~V}$ | $\mathrm{T}_{\mathrm{A}}=125^{\circ} \mathrm{C}$ |  | 8.4 | - | mA |
|  | $\mathrm{V}_{\mathrm{R}}=50 \mathrm{~V}$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | - | 400 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{T}_{\mathrm{A}}=125^{\circ} \mathrm{C}$ |  | 15 | 40 | mA |
| Typical junction capacitance | $4.0 \mathrm{~V}, 1 \mathrm{MHz}$ |  | $\mathrm{C}_{J}$ | 1400 | - | pF |

## Notes

(1) Pulse test: $300 \mu$ s pulse width, $1 \%$ duty cycle
(2) Pulse test: Pulse width $\leq 5 \mathrm{~ms}$

| PARAMETER | SYMBOL | V8PAL50 | UNIT |
| :---: | :---: | :---: | :---: |
| Typical thermal resistance | $\mathrm{R}_{\text {OJA }}{ }^{(1)}$ | 100 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  | $\mathrm{R}_{\text {OJM }}{ }^{(2)}$ | 5 |  |

## Notes

${ }^{(1)}$ Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta J A}$ - junction to ambient
(2) Units mounted on $3 \mathrm{~cm} \times 3 \mathrm{~cm}$ Aluminum, 2 oz . pad area; thermal resistance $R_{\theta J M}$ - junction to mount

| ORDERING INFORMATION (Example) |  |  |  |  |  |
| :--- | :---: | :---: | :---: | :---: | :---: |
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE |  |
| V8PAL50-M3/l | 0.032 | I | 14000 | 13 diameter plastic tape and reel |  |

## RATINGS AND CHARACTERISTICS CURVES

( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ unless otherwise noted)


Fig. 1 - Maximum Forward Currernt Derating Curve

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Fig. 3 - Typical Instantaneous Forward Characteristics


Fig. 4 - Typcial Reverse Leakage Characteristics


Fig. 5 - Typical Junction Capacitance


Fig. 6 - Typcial Transient Thermal Impedance


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Areas

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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)
DO-221BC (SMPA)


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